#### **MAX14714**

## **Compact 6A Smart Power Path Selector**

#### **General Description**

The MAX14714 compact 6A smart power path selector features a low,  $11m\Omega$  (typ)  $R_{ON}$  internal FET and provides the system power from two separate power sources. The device has two switches in SPDT configuration, with bidirectional current-blocking capability when the switch is off.

The MAX14714 features two individual enable inputs to control each power path. Each enable input controls the corresponding path as an independent switch. However, when both paths are enabled, the internal comparator controls the path based on the voltage at input nodes. The device also features an ultra-low supply current in the operating or off states for longer battery-life.

The device is available in a 15-bump (1.2mm x 2.0mm) wafer-level package (WLP) and operates over the -40°C to +85°C extended temperature range.

### **Applications**

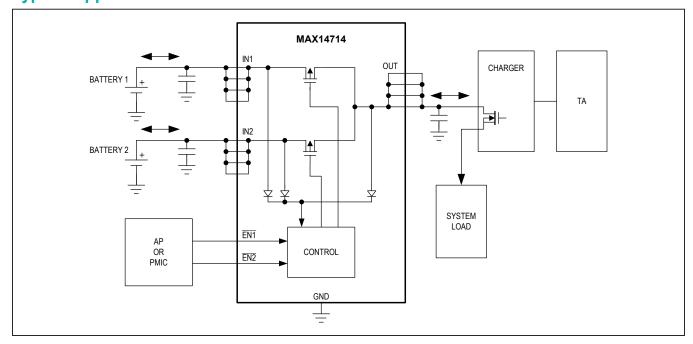
- Smartphones
- Tablet PCs
- e-Readers
- Wearables

#### **Features and Benefits**

- Provides Robust Bidirectional Power Path
  - Wide Operating Input Voltage: +1.6V to +5.5V
  - · 6A Continuous Current Capability
  - Integrated Two 11mΩ (typ) MOSFET Switches
- Enables Simple Power Switch Design
  - Individual Path Control
  - Automatic Power Path Control
  - Automatic Soft-Start
  - · Powered by IN1, IN2, or OUT
- · Significantly Extends Battery Life
  - Ultra-Low Quiescent Supply Current 2.5µA (typ)
  - · Fast Switchover
  - · Optimum Soft-Start Feature
- Compact Package Saves Board Space
  - 15-Bump 1.2mm x 2.0mm WLP

Ordering Information appears at end of data sheet.

# **Typical Application Circuit**





## **Absolute Maximum Ratings**

0.3V to +6V
0.3V to +6V
0.3V to +6V
6A
9A

Continuous Power Dissipation ( $T_A = +70^{\circ}C$ )	
WLP (derate 16.4mW/°C above +70°C)	1312mW
Operating Temperature Range	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Soldering Temperature (reflow)	+260°C

Note 1: DC current is limited by thermal design of the system.

## **Package Thermal Characteristics (Note 2)**

WLP

Junction-to-Ambient Thermal Resistance (θ<sub>JA</sub>) .......52°C/W

Note 2: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **Electrical Characteristics**

 $(V_{IN1}, V_{IN2} = 1.6V \text{ to } 5.5V; T_A = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$  Typical values are at  $V_{IN1}, V_{IN2} = 4.3V; T_A = +25^{\circ}\text{C}.)$  (Note 3)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
SUPPLY OPERATION						
Operating Voltage	V <sub>IN1</sub> V <sub>IN2</sub>		1.6		5.5	V
Shutdown Current	I <sub>SHDN</sub>	EN1 = high and EN2 = high			5.75	μA
Quiescent Current	I <sub>IN1</sub> I <sub>IN2</sub>	EN1 or EN2 = low, I <sub>LOAD</sub> = 0mA		2.5	7.5	μA
INTERNAL FET						
R <sub>ON</sub> (IN1 or IN2 to OUT)	R <sub>ON</sub>	V <sub>IN</sub> _ = 4.3V, I <sub>OUT</sub> = 1A, T <sub>A</sub> = +25°C		11	15	mΩ
Soft-Start Trigger Voltage	V <sub>IN</sub> - V <sub>OUT</sub>			0.95		V
Soft-Start Time	t <sub>SS</sub>		1	5	10	ms
Soft-Start Output dV/dt Limit	I <sub>LIM_SS</sub>	C <sub>LOAD</sub> = 100μF		60		mV/μs
IN1 - IN2 Comparator Rising Threshold	V <sub>THR_IN</sub>	$V_{\rm IN1}$ = 4.3V, $V_{\rm IN2}$ = 4.0V, OUT is initially connected to IN1, $V_{\rm IN2}$ rises until OUT connects to IN2	500		mV	
IN1 - IN2 Comparator Falling Threshold	V <sub>VTHF_IN</sub>	V <sub>IN1</sub> = 4.3V, V <sub>IN2</sub> = 4.6V, OUT is initially connected to IN2, V <sub>IN2</sub> falls until OUT connects to IN1	-500		mV	
LOGIC INPUT (EN1, EN2)						
EN1, EN2 Input Logic High	V <sub>IH</sub>		1.4			V
EN1, EN2 Input Logic Low	V <sub>IL</sub>				0.4	V
EN1, EN2 Input Leakage Current	I <sub>LEAK</sub>	V <sub>EN</sub> _ = 0V, 5.5V	-1		1	μA

## **Electrical Characteristics (continued)**

 $(V_{IN1}, V_{IN2} = 1.6V \text{ to } 5.5V; T_A = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}, \text{ unless otherwise noted.}$  Typical values are at  $V_{IN1}, V_{IN2} = 4.3V; T_A = +25^{\circ}\text{C}.)$  (Note 3)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
DYNAMIC PERFORMANCE (NOTE 4)							
Single-Path Turn-On Time	t <sub>ON</sub>	Time from EN_ low to OUT reaches 90% of IN_ voltage, no load. (Figure 2)		6.5		μs	
Single-Path Turn-Off Time $ \begin{array}{c} V_{\text{IN}} = 3\text{V, } V_{\overline{\text{EN}}} = 0\text{V to 3V, } R_{\text{LOAD}} = 1\text{k}\Omega. \\ \text{Time from } \overline{\text{EN}}_{} \text{ high to OUT reaches 10\% of its initial value. (Figure 2)} \\ \end{array} $			8		μs		
Automatic Switchover Enable Time	t <sub>ASO</sub>	$V_{IN1}$ = 3.8V, $V_{IN2}$ = 4.3V $V_{\overline{E}N1}$ = 0V, $V_{\overline{E}N2}$ = 3V to 0V to OUT reaches 90% of IN2. (Figure 2)		2	5	μs	
Automatic Switchover Break-Before-Make	t <sub>BBM</sub>	$V_{IN1}$ = 3.7V, $V_{IN2}$ = 3V to 4.3V $V_{\overline{E}N1}$ = 0V, $V_{\overline{E}N2}$ = 0V, OUT = 100mA and no load capacitor.	0	0.4	2	μs	
Automatic Switchover Debounce Time	t <sub>ASDEB</sub>	$V_{IN1}$ = 3.3V, $V_{IN2}$ = 4.3V to 3V $V_{\overline{EN1}}$ = 0V, $V_{\overline{EN2}}$ = 0V. (Figure 3)		2		μs	

Note 3: All devices are 100% production tested at T<sub>A</sub> = +25°C. Specifications over the operating temperature range are guaranteed by design.

Note 4: All timing is measured using 20% and 80% levels unless otherwise specified.

## **Timing Diagrams**

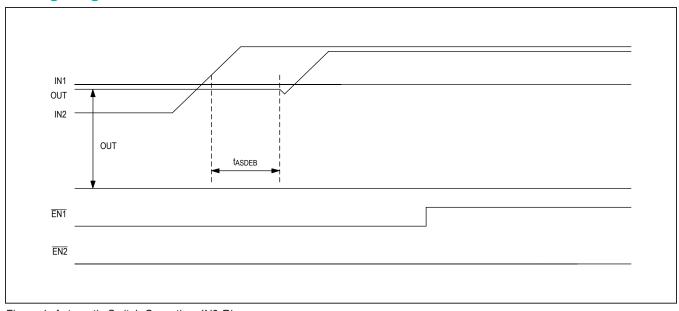


Figure 1. Automatic Switch Operation: IN2 Rise

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# **Timing Diagrams (continued)**

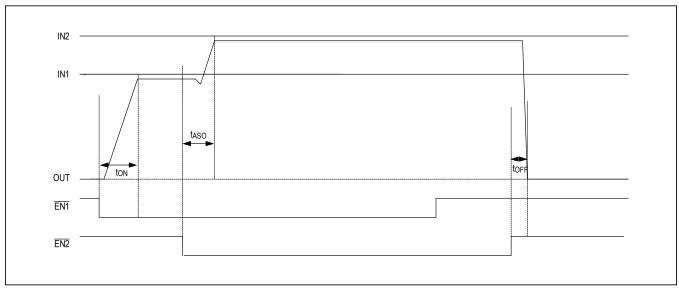


Figure 2. Automatic Switch Operation: EN2 On (Time scale is exaggerated for easy recognition in the waveform)

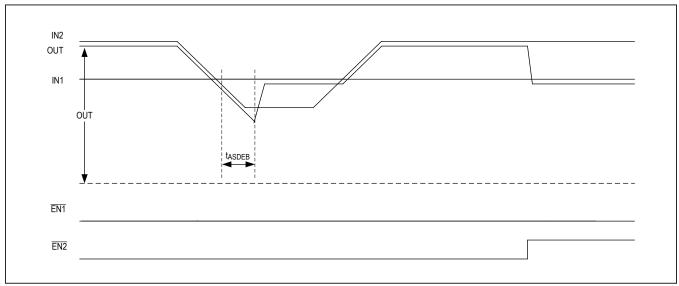
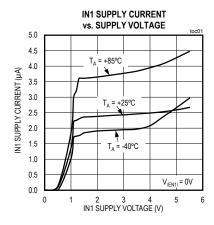
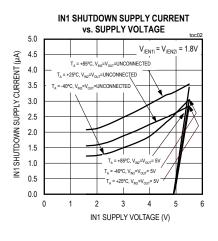


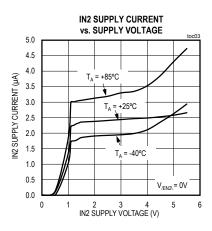
Figure 3: Automatic Switch Operation: IN2 Sag (Time scale is exaggerated for easy recognition in the waveform)

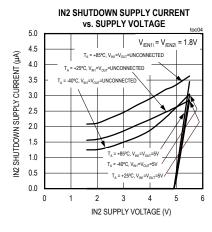
## **Typical Operating Characteristics**

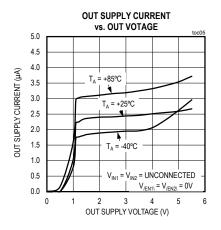
 $(C_{IN1,IN2} = 0.1 \mu F, C_{OUT} = 100 \mu F, T_A = +25 ^{\circ}C$ , unless otherwise noted.)

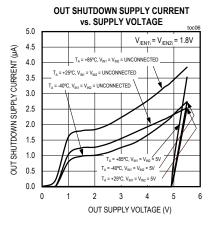


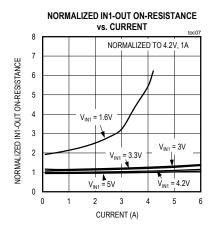


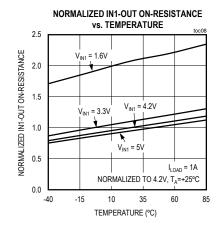


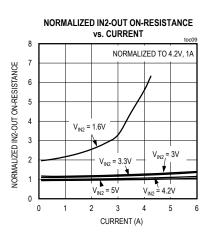






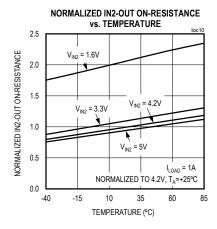


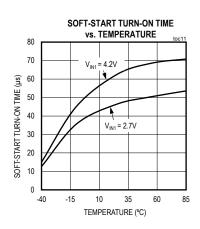


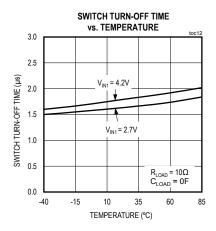


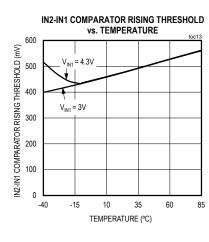
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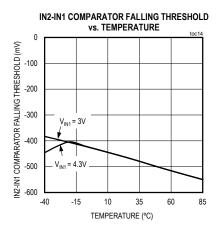
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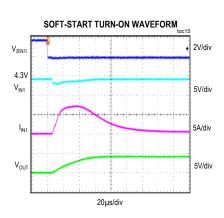


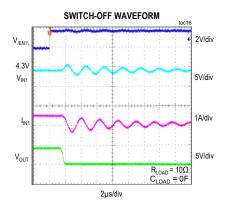


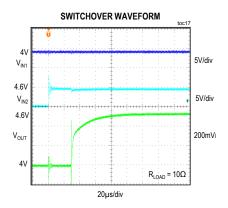


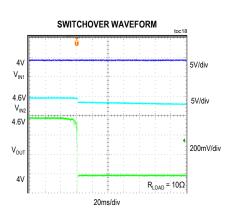






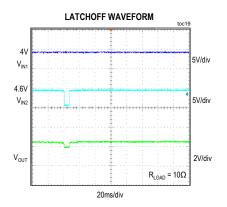


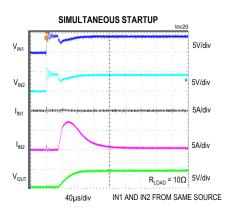




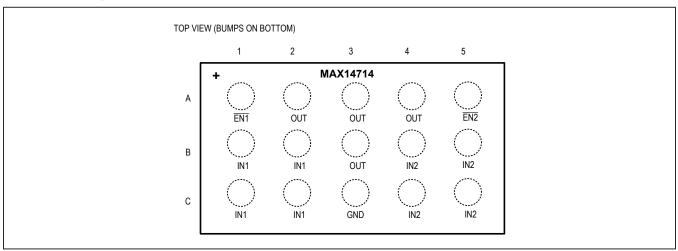
# **Typical Operating Characteristics (continued)**

 $(C_{IN1,IN2}$  = 0.1µF,  $C_{OUT}$  = 100µF,  $T_A$  = +25°C, unless otherwise noted.)





## **Bump Configuration**



# **Bump Description**

BUMP	NAME	FUNCTION	
A1	EN1	Active-Low Enable Input for IN1, Switch 1.	
A2, A3, A4, B3	OUT	Common Switch Output.	
A5	EN2	Active-Low Enable Input for IN2, Switch 2.	
B1, B2, C1, C2 IN1 Power Input 1.			
B4, B5, C4, C5	IN2	Power Input 2.	
C3	GND	Ground.	

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#### **Detailed Description**

The MAX14714 compact 6A smart power path selector device features a low,  $11m\Omega$  (typ)  $R_{ON}$  internal FET and provides the system power from two separate power sources. The device has two switches in SPDT configuration, with a bidirectional current-blocking capability when the switch is turned off.

The MAX14714 features two individual enable inputs to control each power path. Each enable input controls the corresponding path as an independent switch. However, when both paths are enabled, the internal comparator controls the path based on voltage at input nodes to auto-select the higher voltage input.

#### **Enable Inputs**

EN1 and EN2 active-low enable inputs control the two switches position. (Table 1)

#### **Soft-Start**

When a switch is enabled, and if the voltage difference between IN\_ and OUT is greater than 0.95V (typ), the device performs soft-start for 5ms (typ) to prevent high inrush current. During soft-start, the output dV/dt is limited to  $60\text{mV/}\mu\text{s}$  (typ). The soft-start feature is bidirectional for either IN\_ or OUT supply.

#### **Auto-Selection**

When both  $\overline{\text{EN1}}$  and  $\overline{\text{EN2}}$  are low, the device is in autoselection mode and the switch with higher voltage on input is turned on. A difference of V<sub>THR IN</sub> (500mV, typ)

**Table 1. Enable Control** 

EN1	EN2	SWITCH STATUS		
0	0	Auto Selection: switch 1 or switch 2 on*		
1	0	Switch 2 on, switch 1 off		
0	1	Switch 1 on, switch 2 off		
1	1	Switch 1 and switch 2 both off		

\*When voltages on IN1 and IN2 are about the same, the device selects IN2 as the supply source. Please refer to Auto-Selection for details.

between IN1 and IN2 is required in order to switch to the higher supply voltage.

Once the device selects the switch, the switch is on as long as the other input is not higher by  $V_{THR\_IN}$ . If frequent jittering is expected from the power source, manual selection is recommended once the power source is stabilized. If auto-selection latchoff is preferred, please contact the factory for a latchoff option.

In case voltages on IN1 and IN2 are about the same, and  $\overline{\text{EN1}}$  and  $\overline{\text{EN2}}$  both go from high to low, the device selects IN2 as the supply source. After this initial choice, normal auto-selection resumes.

#### **Bidirectional Current-Blocking**

The bidirectional FET switch prevents current flowing from either side when the switch is off.

# **Ordering Information**

PART	ENABLE POLARITY	TEMP RANGE	BUMP-PACKAGE
MAX14714EWL+	ACTIVE-LOW	-40°C to +85°C	15 WLP

<sup>+</sup>Denotes a lead(Pb)-free/RoHS-compliant package.

# **Chip Information**

PROCESS: BiCMOS

## **Package Information**

For the latest package outline information and land patterns (footprints), go to <a href="www.maximintegrated.com/packages">www.maximintegrated.com/packages</a>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE	PACKAGE	OUTLINE	LAND
TYPE	CODE	NO.	PATTERN NO.
15 WLP	W151E2+1	21-1031	Refer to Application Note 1891

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### MAX14714

# Compact 6A Smart Power Path Selector

## **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	9/14	Initial release	_

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

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